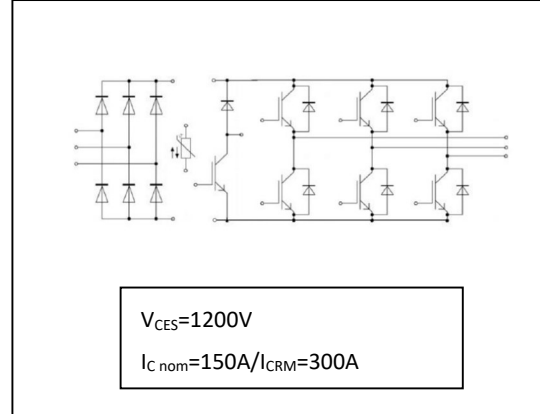


### 1200V 150A IGBT PIM Module

### 1200V 150A IGBT PIM 模块



#### Features:

- 1200V Trench+ Field Stop technology
- Freewheeling diodes with fast and soft reverse recovery
- $V_{CE(sat)}$  with positive temperature coefficient
- Low switching losses
- Short circuit ruggedness

#### Typical Applications:

- Motor drives
- Servo drives

#### 产品特性:

- 1200V 沟槽栅+场截止技术
- 快速的软恢复特性续流二极管
- 导通压降具有正温度系数
- 低开关损耗
- 良好的短路稳定性

#### 典型应用:

- 电机驱动
- 伺服驱动

## IGBT, Inverter / IGBT, 逆变器

### Maximum Rated Values / 最大额定值

Item	Symbol	Conditions	Value	Units
集电极-发射极电压 Collector-emitter voltage	$V_{CES}$	$T_{vj}=25^{\circ}\text{C}$	1200	V
连续集电极直流电流 Continuous DC collector current	$I_c$	$T_c=100^{\circ}\text{C}$	150	A
集电极重复峰值电流 Peak repetitive collector current	$I_{CRM}$	$t_p=1\text{ms}$	300	A
栅极-发射极峰值电压 Maximum gate-emitter voltage	$V_{GES}$		$\pm 20$	V
总功率损耗 Total power dissipation	$P_{tot}$	$T_c=25^{\circ}\text{C}, T_{vj}=175^{\circ}\text{C}$	887	W

### Characteristic Values / 特征值

Item	Symbol	Conditions	Min.	Typ.	Max.	Units
集电极-发射极饱和电压 Collector-emitter saturation voltage	$V_{CE(sat)}$	$I_c=150\text{A}, V_{GE}=15\text{V}$		$T_{vj}=25^{\circ}\text{C}$ $T_{vj}=125^{\circ}\text{C}$	1.65 1.90	V
栅极阈值电压 Gate threshold voltage	$V_{GE(th)}$	$I_c=6\text{mA}, V_{CE}=V_{GE}, T_{vj}=25^{\circ}\text{C}$	5.6	6.3	7.0	V
内部栅极电阻 Internal gate resistor	$R_{Gint}$	$T_{vj}=25^{\circ}\text{C}$		2.5		$\Omega$
输入电容 Input capacitance	$C_{ies}$	$f=1\text{MHz}, T_{vj}=25^{\circ}\text{C}, V_{CE}=25\text{V}, V_{GE}=0\text{V}$		10.6		nF
反向传输电容 Reverse transfer capacitance	$C_{res}$	$f=1\text{MHz}, T_{vj}=25^{\circ}\text{C}, V_{CE}=25\text{V}, V_{GE}=0\text{V}$		0.54		nF
集电极-发射极截止电流 Collector-emitter cut-off current	$I_{CES}$	$V_{CE}=1200\text{V}, V_{GE}=0\text{V}, T_{vj}=25^{\circ}\text{C}$			1.00	mA
栅极-发射极漏电流 Gate-emitter leakage current	$I_{GES}$	$V_{CE}=0\text{V}, V_{GE}=20\text{V}, T_{vj}=25^{\circ}\text{C}$			500	nA
开通延迟时间(电感负载) Turn-on delay time, inductive load	$t_{d(on)}$		$T_{vj}=25^{\circ}\text{C}$ $T_{vj}=125^{\circ}\text{C}$	72 80		ns
上升时间(电感负载) Rise time, inductive load	$t_r$		$T_{vj}=25^{\circ}\text{C}$ $T_{vj}=125^{\circ}\text{C}$	74 78		ns
关断延迟时间(电感负载) Turn-off delay time, inductive load	$t_{d(off)}$	$I_c=150\text{A}, V_{CE}=600\text{V}$ $V_{GE}=-15\text{V}\dots+15\text{V}$	$T_{vj}=25^{\circ}\text{C}$ $T_{vj}=125^{\circ}\text{C}$	413 480		ns
下降时间(电感负载) Fall time, inductive load	$t_f$	$R_{Gon}=5.1\Omega$ $R_{Goff}=5.1\Omega$ Inductive Load	$T_{vj}=25^{\circ}\text{C}$ $T_{vj}=125^{\circ}\text{C}$	56 60		ns
开通损耗能量(每脉冲) Turn-on energy loss per pulse	$E_{on}$		$T_{vj}=25^{\circ}\text{C}$ $T_{vj}=125^{\circ}\text{C}$	17.2 24.8		mJ
关断损耗能量(每脉冲) Turn-off energy loss per pulse	$E_{off}$		$T_{vj}=25^{\circ}\text{C}$ $T_{vj}=125^{\circ}\text{C}$	12.4 18.6		mJ
短路数据 SC data	$I_{sc}$	$V_{GE}=-15\text{V}\dots+15, V_{CC}=600\text{V}$ $V_{CEmax}=V_{CES}-L_{SCE} \cdot di/dt, t_p=10\mu\text{s}, T_{vj}=25^{\circ}\text{C}$		650		A
结-外壳热阻 Thermal resistance, junction to case	$R_{th(jc)}$	Per IGBT / 每个 IGBT			0.169	K/W
工作温度 Temperature under switching conditions	$T_{vjop}$		-40		150	$^{\circ}\text{C}$

### Diode, Inverter / 二极管, 逆变器

#### Maximum Rated Values / 最大额定值

Item	Symbol	Conditions	Value	Units
反向重复峰值电压 Peak repetitive reverse voltage	$V_{RRM}$	$T_{vj}=25^{\circ}\text{C}$	1200	V
连续正向直流电流 Continuous DC forward current	$I_F$		150	A
正向重复峰值电流 Peak repetitive forward current	$I_{FRM}$	$t_p=1\text{ms}$	300	A

#### Characteristic Values / 特征值

Item	Symbol	Conditions	Min.	Typ.	Max.	Units
正向电压 Forward voltage	$V_F$	$I_F=150\text{A}$				
			$T_{vj}=25^{\circ}\text{C}$	1.85	2.00	
			$T_{vj}=125^{\circ}\text{C}$	1.80		V
			$T_{vj}=150^{\circ}\text{C}$	1.80		
反向恢复峰值电流 Peak reverse recovery current	$I_{rm}$	$I_F=150\text{A}$				
			$T_{vj}=25^{\circ}\text{C}$	65		A
			$T_{vj}=125^{\circ}\text{C}$	80		
反向恢复电荷 Reverse recovery charge	$Q_{rr}$	$-di_F/dt_{off}=1600\text{A}/\mu\text{s}$ $V_R = 600\text{V}$				
			$T_{vj}=25^{\circ}\text{C}$	12.4		$\mu\text{C}$
			$T_{vj}=125^{\circ}\text{C}$	24.5		
反向恢复损耗 (每脉冲) Reverse recovery energy (per pulse)	$E_{rec}$	$V_{GE}=-15\text{V}$				
			$T_{vj}=25^{\circ}\text{C}$	3.6		mJ
			$T_{vj}=125^{\circ}\text{C}$	7.3		
结-外壳热阻 Thermal resistance, junction to case	$R_{thJC}$	Per diode / 每个二极管			0.30	K/W
工作温度 Temperature under switching conditions	$T_{vjop}$		-40		150	$^{\circ}\text{C}$

### IGBT, Brake Chopper / IGBT, 刹车

#### Maximum Rated Values / 最大额定值

Item	Symbol	Conditions	Value	Units
集电极-发射极电压 Collector-emitter voltage	$V_{CEs}$	$T_{vj}=25^{\circ}C, I_c=1mA, V_{GE}=0V$	1200	V
连续集电极直流电流 Continuous DC collector current	$I_c$	$T_c=100^{\circ}C, T_{vj}=175^{\circ}C$	100	A
集电极重复峰值电流 Peak repetitive collector current	$I_{CRM}$	$t_p=1ms$	200	A
栅极-发射极峰值电压 Maximum gate-emitter voltage	$V_{GES}$		$\pm 20$	V
总功率损耗 Total power dissipation	$P_{tot}$	$T_c=25^{\circ}C, T_{vj}=175^{\circ}C$	652	W

#### Characteristic Values / 特征值

Item	Symbol	Conditions	Min.	Typ.	Max.	Units
集电极-发射极饱和电压 Collector-emitter saturation voltage	$V_{CE(sat)}$	$I_c=100A, V_{GE}=15V$		$T_{vj}=25^{\circ}C$ 1.65 $T_{vj}=125^{\circ}C$ 1.95 $T_{vj}=150^{\circ}C$ 2.05	2.00	V
栅极阈值电压 Gate threshold voltage	$V_{GE(th)}$	$I_c=3.3mA, V_{CE}=10V, T_{vj}=25^{\circ}C$	5.0	5.7	6.5	V
栅极电荷 Gate charge	$Q_G$	$V_{GE}=-15V...+15V$		0.90		$\mu C$
输入电容 Input capacitance	$C_{ies}$	$f=1MHz, T_{vj}=25^{\circ}C, V_{CE}=25V, V_{GE}=0V$		6.80		nF
反向传输电容 Reverse transfer capacitance	$C_{res}$	$f=1MHz, T_{vj}=25^{\circ}C, V_{CE}=25V, V_{GE}=0V$		0.30		nF
集电极-发射极截止电流 Collector-emitter cut-off current	$I_{CES}$	$V_{CE}=1200V, V_{GE}=0V, T_{vj}=25^{\circ}C$			1.00	mA
栅极-发射极漏电流 Gate-emitter leakage current	$I_{GES}$	$V_{CE}=0V, V_{GE}=20V, T_{vj}=25^{\circ}C$			500	nA
开通延迟时间(电感负载) Turn-on delay time, inductive load	$t_{d(on)}$			$T_{vj}=25^{\circ}C$ 145 $T_{vj}=125^{\circ}C$ 155		ns
上升时间(电感负载) Rise time, inductive load	$t_r$			$T_{vj}=25^{\circ}C$ 28 $T_{vj}=125^{\circ}C$ 40		ns
关断延迟时间(电感负载) Turn-off delay time, inductive load	$t_{d(off)}$	$I_c=100A, V_{CE}=600V$ $V_{GE}=-15V...+15V$		$T_{vj}=25^{\circ}C$ 325 $T_{vj}=125^{\circ}C$ 360		ns
下降时间(电感负载) Fall time, inductive load	$t_f$	$R_{Gon}=1.6\Omega$ $R_{Goff}=1.6\Omega$ Inductive Load		$T_{vj}=25^{\circ}C$ 110 $T_{vj}=125^{\circ}C$ 170		ns
开通损耗能量(每脉冲) Turn-on energy loss per pulse	$E_{on}$			$T_{vj}=25^{\circ}C$ 4.9 $T_{vj}=125^{\circ}C$ 7.2		mJ
关断损耗能量(每脉冲) Turn-off energy loss per pulse	$E_{off}$			$T_{vj}=25^{\circ}C$ 6.5 $T_{vj}=125^{\circ}C$ 9.7		mJ
短路数据 SC data	$I_{sc}$	$V_{GE}=-15V...+15, V_{CC}=600V$ $V_{CEmax}=V_{CES}-L_{SCE} \cdot di/dt, t_p=10\mu s, T_{vj}=25^{\circ}C$		450		A
结-外壳热阻 Thermal resistance, junction to case	$R_{thJC}$	Per IGBT / 每个 IGBT			0.23	K/W
工作温度 Temperature under switching conditions	$T_{vjop}$		-40		150	$^{\circ}C$

### Diode, Brake Chopper / 二极管, 刹车

#### Maximum Rated Values / 最大额定值

Item	Symbol	Conditions	Value	Units
反向重复峰值电压 Peak repetitive reverse voltage	$V_{RRM}$	$T_{vj}=25^{\circ}\text{C}$	1200	V
连续正向直流电流 Continuous DC forward current	$I_F$		50	A
正向重复峰值电流 Peak repetitive forward current	$I_{FRM}$	$t_p=1\text{ms}$	100	A

#### Characteristic Values / 特征值

Item	Symbol	Conditions	Min.	Typ.	Max.	Units
正向电压 Forward voltage	$V_F$	$I_F=50\text{A}$		$T_{vj}=25^{\circ}\text{C}$ 1.85 $T_{vj}=125^{\circ}\text{C}$ 1.80 $T_{vj}=150^{\circ}\text{C}$ 1.80		V
反向恢复峰值电流 Peak reverse recovery current	$I_{rr}$	$I_F=50\text{A}$		$T_{vj}=25^{\circ}\text{C}$ 7.00 $T_{vj}=125^{\circ}\text{C}$ 11.2		A
反向恢复电荷 Reverse recovery charge	$Q_r$	$-di_F/dt_{off}=2300\text{A}/\mu\text{s}$ $V_R = 600\text{V}$		$T_{vj}=25^{\circ}\text{C}$ 80 $T_{vj}=125^{\circ}\text{C}$ 85		$\mu\text{C}$
反向恢复损耗 (每脉冲) Reverse recovery energy (per pulse)	$E_{rec}$	$V_{GE}=-15\text{V}$		$T_{vj}=25^{\circ}\text{C}$ 2.8 $T_{vj}=125^{\circ}\text{C}$ 4.9		mJ
结-外壳热阻 Thermal resistance, junction to case	$R_{thJC}$	Per diode / 每个二极管			0.68	K/W
工作温度 Temperature under switching conditions	$T_{vjop}$		-40		150	$^{\circ}\text{C}$

### Diode, Rectifier / 二极管, 整流

#### Maximum Rated Values / 最大额定值

Item	Symbol	Conditions	Value	Units
反向重复峰值电压 Peak repetitive reverse voltage	$V_{RRM}$	$T_{vj}=25^{\circ}C$	1600	V
最大正向均方根电流(每芯片) Maximum RMS forward current per chip	$I_{FRMSM}$	$T_H = 100^{\circ}C$	150	A
最大整流器输出均方根电流 Maximum RMS current at rectifier output	$I_{RMSM}$	$T_H = 100^{\circ}C$	150	A
正向浪涌电流 Surge forward current	$I_{FSM}$	$t_p=10ms, T_{vj}=25^{\circ}C, \sin 180^{\circ}$	1600	A
$I^2t$ -值 $I^2t$ -value	$I^2t$	$t_p=10ms, T_{vj}=25^{\circ}C, \sin 180^{\circ}$	13000	A <sup>2</sup> S

#### Characteristic Values / 特征值

Item	Symbol	Conditions	Min.	Typ.	Max.	Units
正向电压 Forward voltage	$V_F$	$T_{vj}=150^{\circ}C, I_F=100A$		1.0		V
反向电流 Reverse current	$I_R$	$T_{vj}=125^{\circ}C, V_R=1600V$			2.0	mA
结-外壳热阻 Thermal resistance, junction to case	$R_{thJC}$	Per diode / 每个二极管			0.28	K/W
工作温度 Temperature under switching conditions	$T_{vjop}$		-40		150	$^{\circ}C$

#### NTC-Thermistor / 负温度系数热敏电阻

#### Characteristic Values / 特征值

Item	Symbol	Conditions	Value	Units
额定电阻值 Rated resistance	$R_{25}$	$T_c=25^{\circ}C$	5.00	k $\Omega$
B-值 B-value	$B_{25/50}$	$R_2=R_{25} \exp[B_{25/50}(1/T_2-1/(298.15K))]$	3375	K

#### Module / 模块

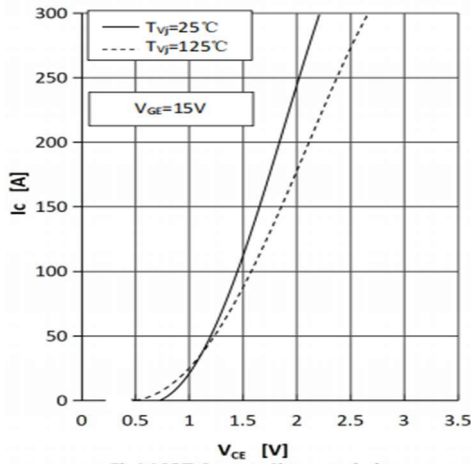
Item	Symbol	Conditions	Value	Units
绝缘测试电压 Isolation test voltage	$V_{ISOL}$	RMS, f=50Hz, t=1min	2.5	kV
模块基板材料 Material of module baseplate			Cu	
内部绝缘 Internal isolation		基本绝缘 (class 1, IEC 61140) Basic insulation (class 1, IEC 61140)	$Al_2O_3$	
爬电距离 Creepage distance			10	mm
电气间隙 Clearance			7.5	mm
相对电痕指数 Comperative tracking index	CTI		> 200	

Item	Symbol	Conditions	Min.	Typ.	Max.	Units
杂散电感, 模块 Stray inductance module	$L_{SCE}$			25		nH
模块引脚电阻, 端子-芯片 Module Lead Resistance, Terminals-Chip	$R_{CC+EE}$	$T_H=25^{\circ}C$ , 每个开关/perswitch		1.1		m $\Omega$
储存温度 Storage temperature	$T_{stg}$		-40		125	$^{\circ}C$
模块安装的安装扭矩 Mounting torque for module mounting	M		3.00		6.00	Nm
重量 Weight	G			300		g

输出特性 IGBT, 逆变器 (典型)

Output characteristic IGBT, Inverter (typical)

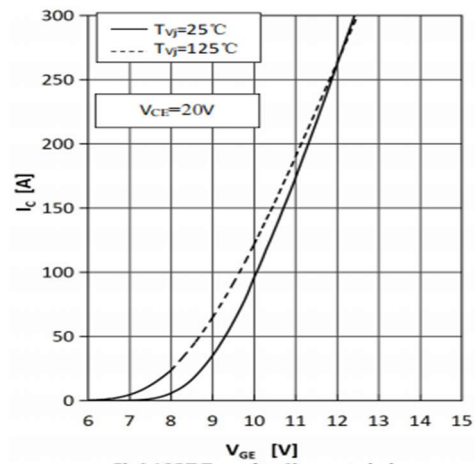
$I_c = f(V_{CE})$



转移特性 IGBT, 逆变器 (典型)

Transfer characteristic IGBT, Inverter (typical)

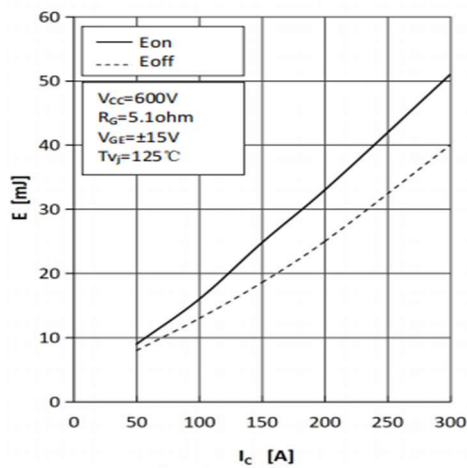
$I_c = f(V_{GE})$



开关损耗 IGBT, 逆变器 (典型)

Switching losses IGBT, Inverter (typical)

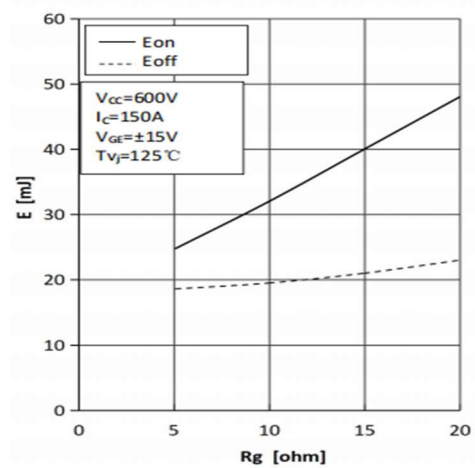
$E = f(I_c)$



开关损耗 IGBT, 逆变器 (典型)

Switching losses IGBT, Inverter (typical)

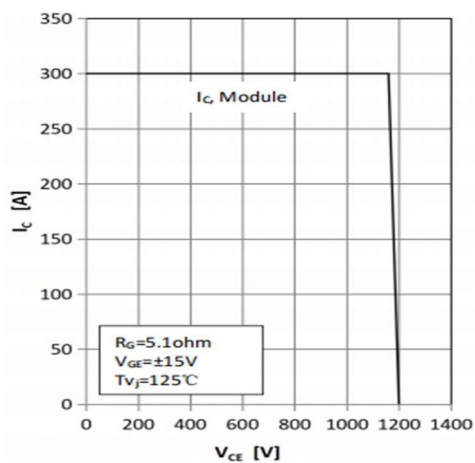
$E = f(R_g)$



反偏安全工作区 IGBT, 逆变器 (RBSOA)

Reverse bias safe operating area IGBT, Inverter (RBSOA)

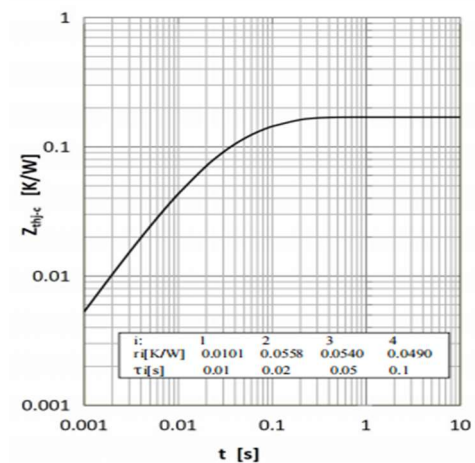
$I_c = f(V_{CE})$



瞬态热阻抗 IGBT, 逆变器

Transient thermal impedance IGBT, Inverter

$Z_{thjc} = f(t)$

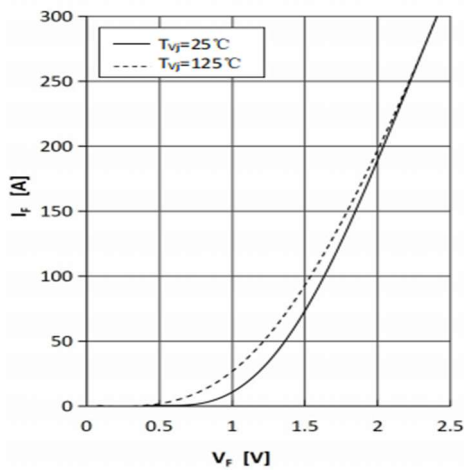




输出特性 FRD, 逆变器 (典型)

Output characteristic FRD, Inverter (typical)

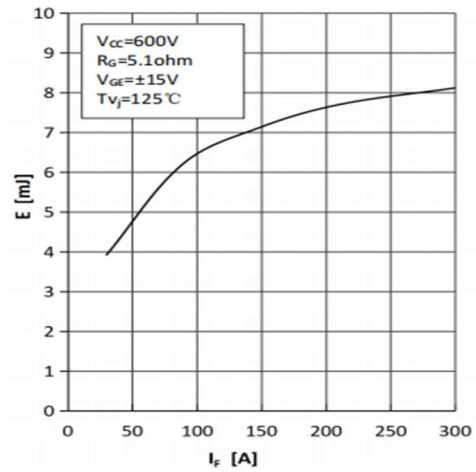
$I_f=f(V_f)$



开关损耗 FRD, 逆变器 (典型)

Switching losses FRD, Inverter (typical)

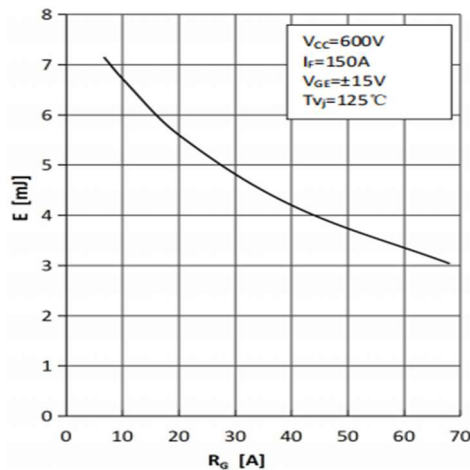
$E=f(I_f)$



开关损耗 FRD, 逆变器 (典型)

Switching losses FRD, Inverter (typical)

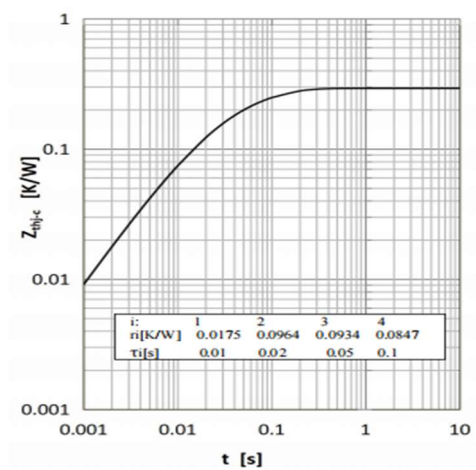
$E=f(R_g)$



瞬态热阻抗 FRD, 逆变器

Transient thermal impedance FRD, Inverter

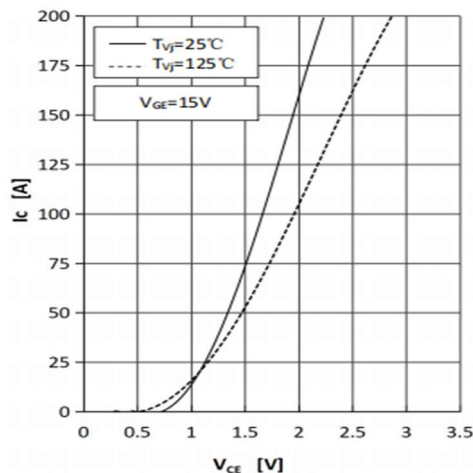
$Z_{thjc}=f(t)$



输出特性 IGBT, 刹车 (典型)

Output characteristic IGBT, Brake Chopper (typical)

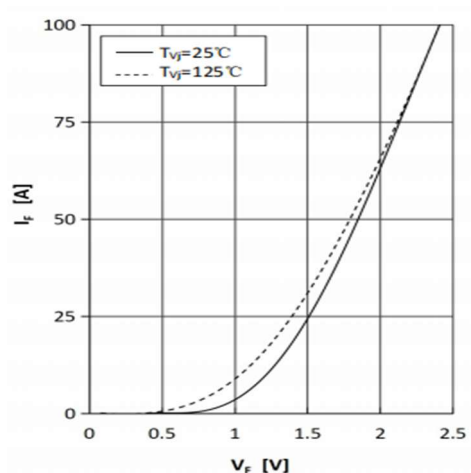
$I_c=f(V_{CE})$



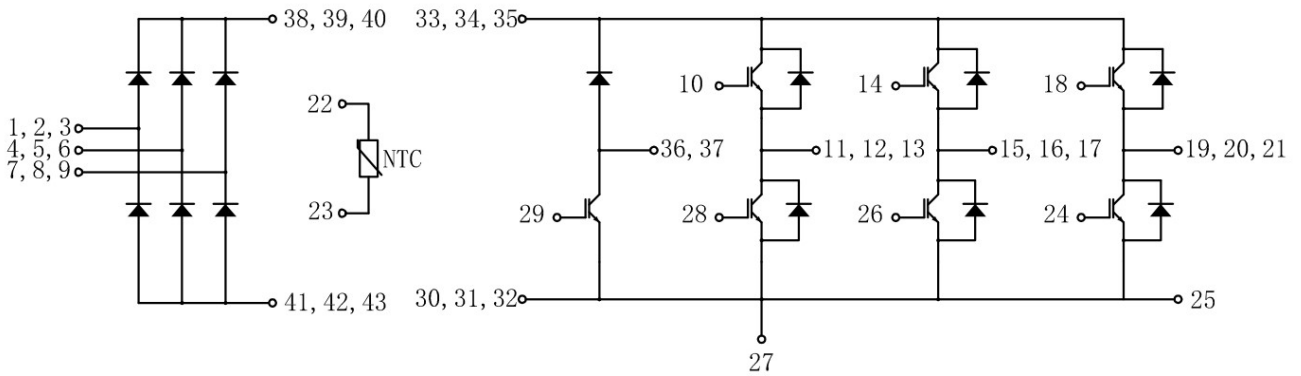
正向偏压特性 FRD, 刹车 (典型)

Forward characteristic of FRD, Brake Chopper (typical)

$I_f=f(V_f)$



### Circuit diagram headline / 接线图



### Package outlines / 封装尺寸

